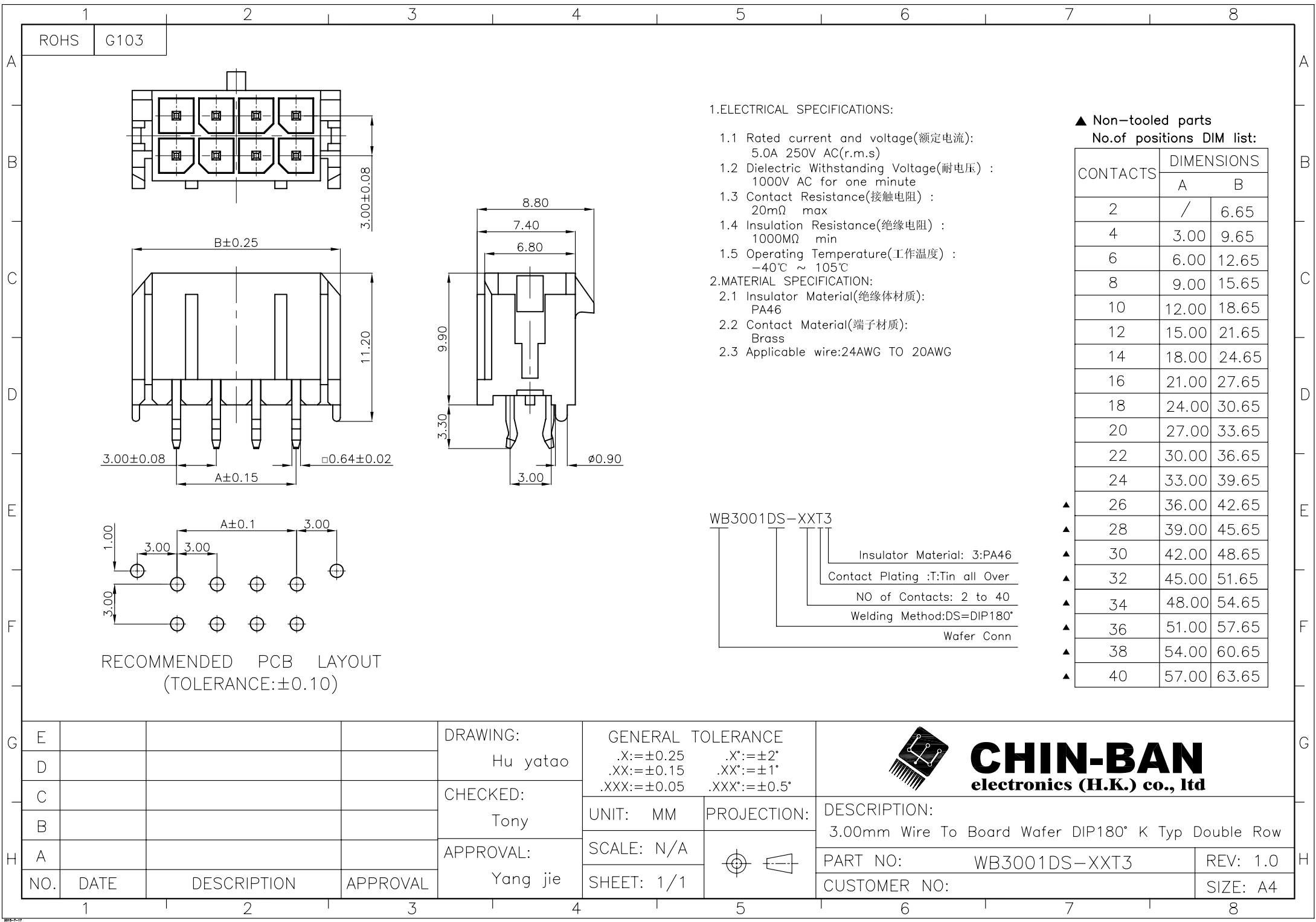




ROHS G103

1.ELECTRICAL SPECIFICATIONS:

- 1.1 Rated current and voltage(额定电流):
5.0A 250V AC(r.m.s)
- 1.2 Dielectric Withstanding Voltage(耐电压) :
1000V AC for one minute
- 1.3 Contact Resistance(接触电阻) :
20mΩ max
- 1.4 Insulation Resistance(绝缘电阻) :
1000MΩ min
- 1.5 Operating Temperature(工作温度) :
-40℃ ~ 105℃

2.MATERIAL SPECIFICATION:

- 2.1 Insulator Material(绝缘体材质):
PA46
- 2.2 Contact Material(端子材质):
Brass
- 2.3 Applicable wire:24AWG TO 20AWG

▲ Non-tooled parts
No.of positions DIM list:

CONTACTS	DIMENSIONS	
	A	B
2	/	6.65
4	3.00	9.65
6	6.00	12.65
8	9.00	15.65
10	12.00	18.65
12	15.00	21.65
14	18.00	24.65
16	21.00	27.65
18	24.00	30.65
20	27.00	33.65
22	30.00	36.65
24	33.00	39.65
▲ 26	36.00	42.65
▲ 28	39.00	45.65
▲ 30	42.00	48.65
▲ 32	45.00	51.65
▲ 34	48.00	54.65
▲ 36	51.00	57.65
▲ 38	54.00	60.65
▲ 40	57.00	63.65

WB3001DS-XXT3

Insulator Material: 3:PA46
Contact Plating :T:tin all Over
NO of Contacts: 2 to 40
Welding Method:DS=DIP180°
Wafer Conn

RECOMMENDED PCB LAYOUT
(TOLERANCE:±0.10)

DRAWING:
Hu yatao

CHECKED:
Tony

APPROVAL:
Yang jie

GENERAL TOLERANCE

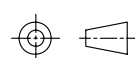
.X:=±0.25 .X*:=±2°
.XX:=±0.15 .XX*:=±1°
.XXX:=±0.05 .XXX*:=±0.5°

UNIT: MM

SCALE: N/A

SHEET: 1/1

PROJECTION:



CHIN-BAN
electronics (H.K.) co., Ltd

DESCRIPTION:
3.00mm Wire To Board Wafer DIP180° K Type Double Row

PART NO: WB3001DS-XXT3

REV: 1.0

CUSTOMER NO:

SIZE: A4